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CONFIRMATION NO. 2837

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|---|---|----------------------------------|---|---|--------------------------------|
| <b>SERIAL NUMBER</b><br>10/817,627  | <b>FILING OR 371(c) DATE</b><br>04/01/2004<br><b>RULE</b>   | <b>CLASS</b><br>210              | <b>GROUP ART UNIT</b><br>1723   | <b>ATTORNEY DOCKET NO.</b><br>500155.06 |                                |
| <b>APPLICANTS</b><br>Guy F. Hudson, Boise, ID;  |   |                                  |   |   |                                |
| <b>** CONTINUING DATA *****</b><br>This application is a DIV of 10/155,203 05/23/2002 PAT 6,794,289 which is a CON of 09/289,790 04/09/1999 PAT 6,407,000   |   |                                  |   |   |                                |
| <b>** FOREIGN APPLICATIONS *****</b>  |   |                                  |   |   |                                |
| <b>IF REQUIRED, FOREIGN FILING LICENSE GRANTED</b><br><b>** 07/29/2004</b>  |   |                                  |   |   |                                |
| Foreign Priority claimed <input type="checkbox"/> yes <input checked="" type="checkbox"/> no<br>35 USC 119 (a-d) conditions <input type="checkbox"/> yes <input checked="" type="checkbox"/> no <input type="checkbox"/> Met after Allowance<br>Verified and Acknowledged <input checked="" type="checkbox"/> |   | <b>STATE OR COUNTRY ID</b><br>km | <b>SHEETS DRAWING</b><br>5  | <b>TOTAL CLAIMS</b><br>31               | <b>INDEPENDENT CLAIMS</b><br>2 |
| <b>ADDRESS</b><br>Mark W. Roberts, Ph.D.<br>DORSEY & WHITNEY LLP<br>Suite 3400<br>1420 Fifth Avenue<br>Seattle, WA98101   |   |                                  |   |   |                                |
| <b>TITLE</b><br>Systems for making and using bi-modal abrasive slurries for mechanical and chemical-mechanical planarization of microelectronic-device substrate assemblies   |   |                                  |   |   |                                |
| <b>FILING FEE RECEIVED</b><br>968   | FEES: Authority has been given in Paper<br>No. _____ to charge/credit DEPOSIT ACCOUNT<br>No. _____ for following: |                                  | <input type="checkbox"/> All Fees<br><input type="checkbox"/> 1.16 Fees ( Filing )<br><input type="checkbox"/> 1.17 Fees ( Processing Ext. of time )<br><input type="checkbox"/> 1.18 Fees ( Issue )<br><input type="checkbox"/> Other _____<br><input type="checkbox"/> Credit |   |                                |